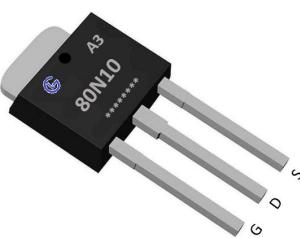


### General Description:

The GL80N10A3 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. The package form is TO-251, which accords with the RoHS standard.

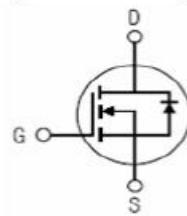
|                         |     |                  |
|-------------------------|-----|------------------|
| $V_{DSS}$               | 100 | V                |
| $I_D$                   | 80  | A                |
| $P_D$                   | 100 | W                |
| $R_{DS(ON)}\text{type}$ | 7.2 | $\text{m}\Omega$ |



### Features:

- $R_{DS(ON)} < 8.5\text{m}\Omega$  @  $V_{GS}=10\text{V}$  (Typ7.2mΩ)
- High density cell design for ultra low  $R_{ds(on)}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Inner Equivalent Principium Chart



### Applications:

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

### Absolute (T<sub>c</sub>= 25°C unless otherwise specified):

| Symbol         | Parameter  | Rating          | Units                 |
|----------------|--|-----------------|-----------------------|
| $V_{DSS}$      | Drain-to-Source Voltage                          | 100             | V                     |
| $I_D$          | Continuous Drain Current                         | 80              | A                     |
| $I_{DM}$       | Pulsed Drain Current                             | 320             | A                     |
| $V_{GS}$       | Gate-to-Source Voltage                           | $\pm 20$        | V                     |
| $P_D$          | Power Dissipation                                | 125             | W                     |
|                | Derating factor                                  | 0.8             | W/ $^{\circ}\text{C}$ |
| $E_{AS}$       | Single pulse avalanche energy <sup>a5</sup>      | 320             | mJ                    |
| $T_J, T_{stg}$ | Operating Junction and Storage Temperature Range | 175, -55 to 175 | $^{\circ}\text{C}$    |



# GL80N10A3

## GL Silicon N-Channel Power MOSFET

**Electrical Characteristics** ( $T_c = 25^\circ\text{C}$  unless otherwise specified):

| OFF Characteristics |                                   |   |        |      |      |               |
|---------------------|-----------------------------------|---|--------|------|------|---------------|
| Symbol              | Parameter                         | Test Conditions                                 | Rating |      |      | Units         |
|                     |                                   |   | Min.   | Typ. | Max. |               |
| $V_{DSS}$           | Drain to Source Breakdown Voltage | $V_{GS}=0V, I_D=250\mu\text{A}$                 | 100    | --   | --   | V             |
| $I_{DSS}$           | Drain to Source Leakage Current   | $V_{DS}=100V, V_{GS}= 0V, T_a=25^\circ\text{C}$ | --     | --   | 1.0  | $\mu\text{A}$ |
| $I_{GSS(F)}$        | Gate to Source Forward Leakage    | $V_{GS}=+20V$                                   | --     | --   | 0.1  | $\mu\text{A}$ |
| $I_{GSS(R)}$        | Gate to Source Reverse Leakage    | $V_{GS}=-20V$                                   | --     | --   | -0.1 | $\mu\text{A}$ |

| ON Characteristics <sup>a3</sup> |                               |                                     |        |      |      |                  |
|----------------------------------|-------------------------------|-------------------------------------|--------|------|------|------------------|
| Symbol                           | Parameter                     | Test Conditions                     | Rating |      |      | Units            |
|                                  |                               |                                     | Min.   | Typ. | Max. |                  |
| $R_{DS(ON)}$                     | Drain-to-Source On-Resistance | $V_{GS}=10V, I_D=40A$               | --     | 7.2  | 8.5  | $\text{m}\Omega$ |
| $V_{GS(\text{TH})}$              | Gate Threshold Voltage        | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$ | 1.0    | 1.7  | 2.5  | V                |

Pulse width  $t_p \leq 380\mu\text{s}, \delta \leq 2\%$

| Dynamic Characteristics <sup>a4</sup> |                              |                         |        |      |      |       |
|---------------------------------------|------------------------------|-------------------------|--------|------|------|-------|
| Symbol                                | Parameter                    | Test Conditions         | Rating |      |      | Units |
|                                       |                              |                         | Min.   | Typ. | Max. |       |
| $g_{fs}$                              | Forward Transconductance     | $V_{DS}=10V, I_D=40A$   | 40     | --   | --   | S     |
| $C_{iss}$                             | Input Capacitance            | $V_{GS}=0V, V_{DS}=50V$ | --     | 4200 | --   | pF    |
| $C_{oss}$                             | Output Capacitance           | $f=1.0\text{MHz}$       | --     | 354  | --   |       |
| $C_{rss}$                             | Reverse Transfer Capacitance |                         | --     | 23   | --   |       |

| Resistive Switching Characteristics <sup>a4</sup> |                                  |                       |        |      |      |       |
|---|----------------------------------|-----------------------|--------|------|------|-------|
| Symbol  | Parameter                        | Test Conditions       | Rating |      |      | Units |
|   |                                  |                       | Min.   | Typ. | Max. |       |
| $t_{d(\text{ON})}$                                | Turn-on Delay Time               | $V_{DD}=50V, I_D=40A$ | --     | 15   | --   | ns    |
| $t_r$   | Rise Time                        |                       | --     | 10   | --   |       |
| $t_{d(\text{OFF})}$                               | Turn-Off Delay Time              |                       | --     | 41   | --   |       |
| $t_f$   | Fall Time                        |                       | --     | 6    | --   |       |
| $Q_g$   | Total Gate Charge                | $V_{DD}=50V, I_D=40A$ | --     | 65   | --   | nC    |
| $Q_{gs}$  | Gate to Source Charge            |                       | --     | 15.3 | --   |       |
| $Q_{gd}$  | Gate to Drain ( "Miller" )Charge |                       | --     | 9    | --   |       |

***GL Silicon N-Channel Power MOSFET***
**Source-Drain Diode Characteristics**

| Symbol          | Parameter  | Test Conditions                          | Rating |      |      | Units |
|-----------------|--|--|--------|------|------|-------|
|                 |  |  | Min.   | Typ. | Max. |       |
| I <sub>S</sub>  | Continuous Source Current <sup>a2</sup> (Body Diode) |  | --     | --   | 80   | A     |
| V <sub>SD</sub> | Diode Forward Voltage <sup>a3</sup>                  | I <sub>S</sub> =80A, V <sub>GS</sub> =0V | --     | --   | 1.2  | V     |

| Symbol           | Parameter                      | Typ. | Units |
|------------------|--------------------------------|------|-------|
| R <sub>θJC</sub> | Junction-to-Case <sup>a2</sup> | 1.25 | °C/W  |

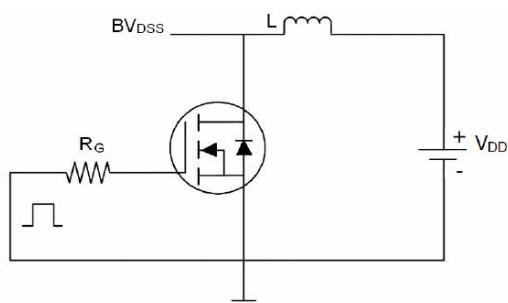
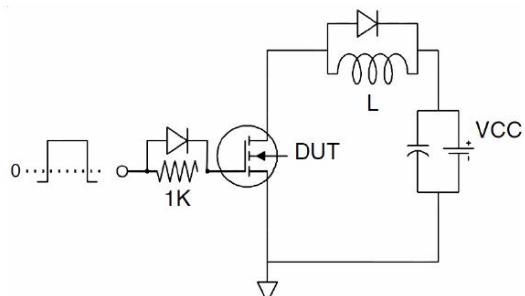
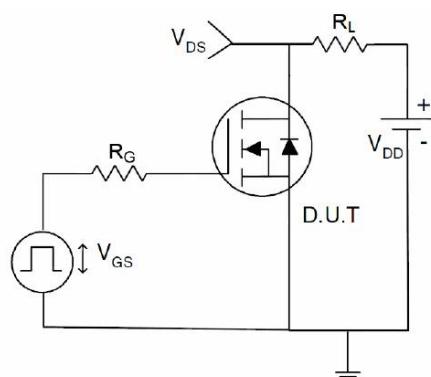
<sup>a1</sup>: Repetitive Rating: Pulse width limited by maximum junction temperature.

<sup>a2</sup>: Surface Mounted on FR4 Board, t≤10sec.

<sup>a3</sup>: Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%.

<sup>a4</sup>: Guaranteed by design, not subject to production

<sup>a5</sup>: EAS condition: T<sub>j</sub>=25°C, V<sub>DD</sub>=50V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω

**Test circuit**
**1) EAS test Circuit**

**2) Gate charge test Circuit**

**3) Switch Time Test Circuit**


### Characteristics Curve:

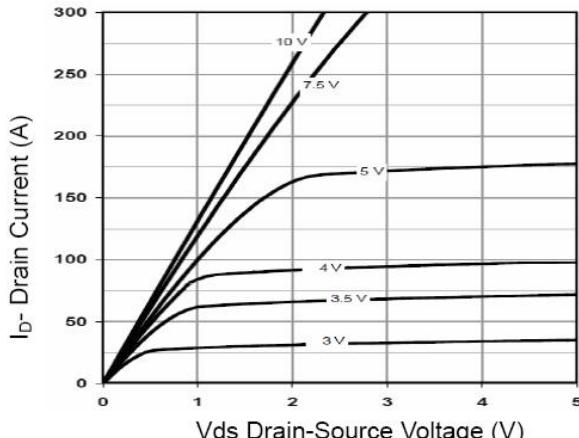


Figure 1 Output Characteristics

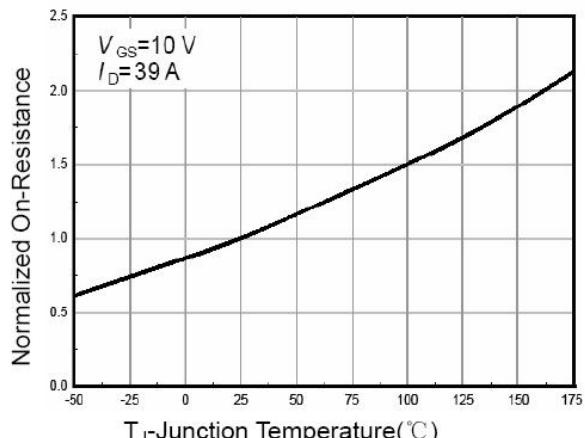


Figure 4  $R_{DSON}$ -JunctionTemperature

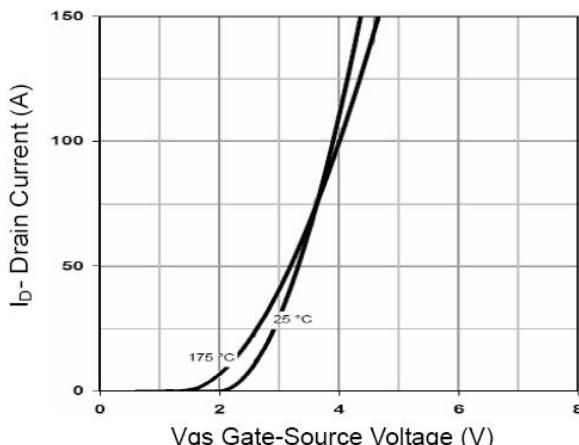


Figure 2 Transfer Characteristics

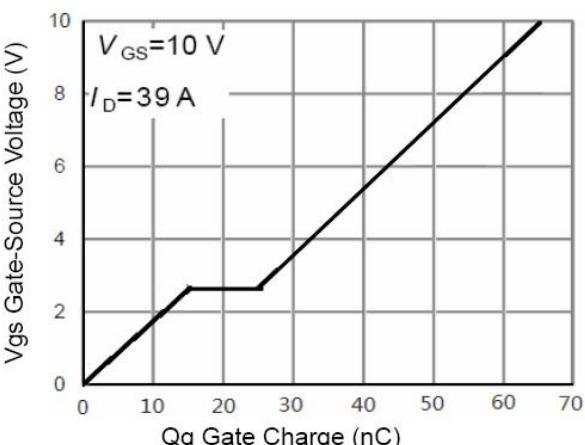


Figure 5 Gate Charge

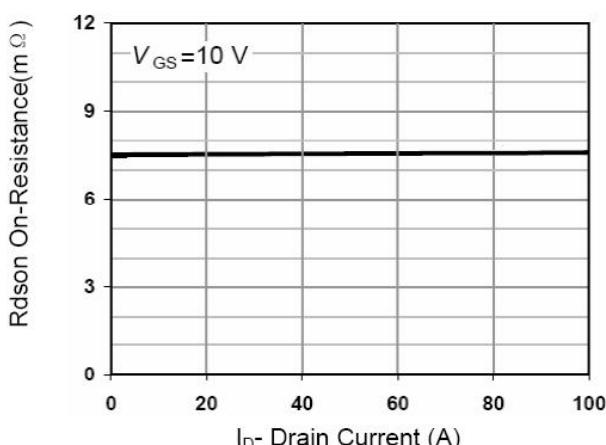


Figure 3  $R_{DSON}$ - Drain Current

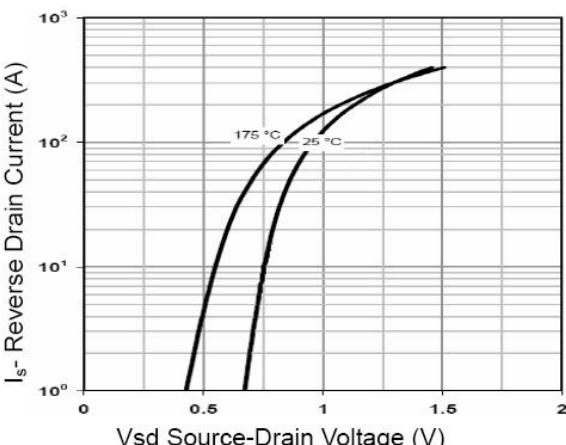
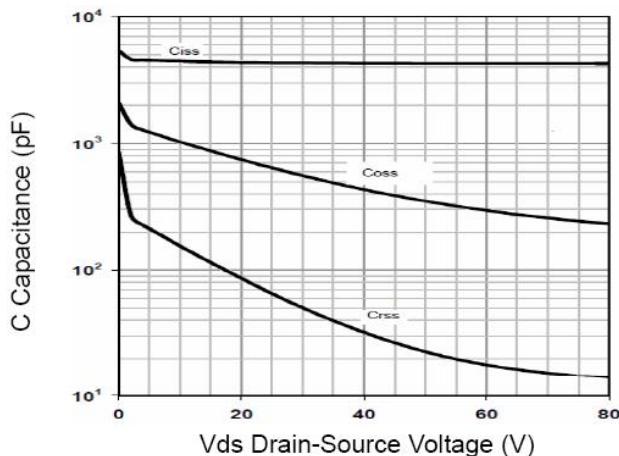
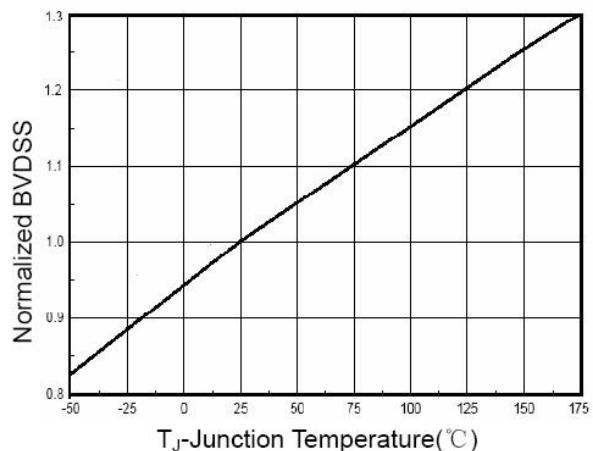


Figure 6 Source- Drain Diode Forward

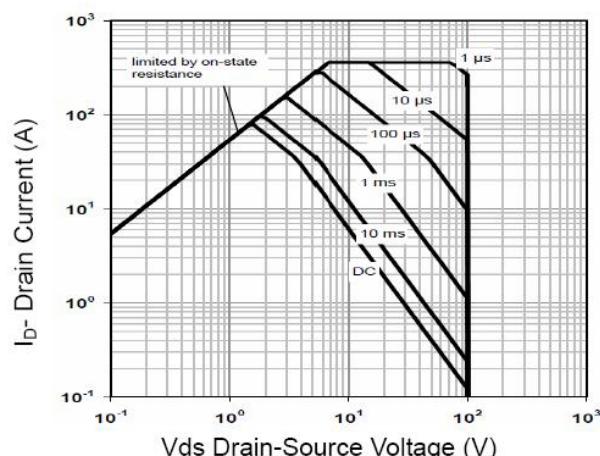
## GL Silicon N-Channel Power MOSFET



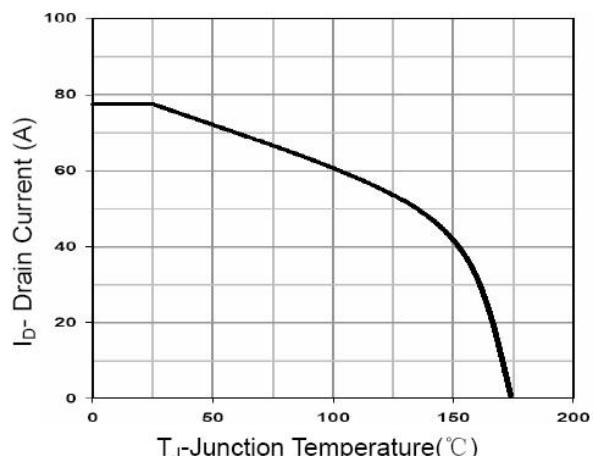
**Figure 7 Capacitance vs Vds**



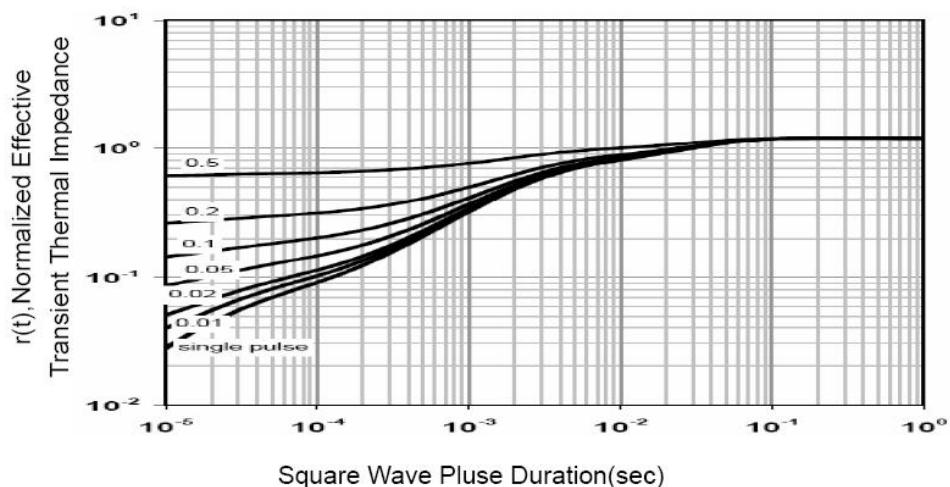
**Figure 9 BV<sub>DSS</sub> vs Junction Temperature**



**Figure 8 Safe Operation Area**



**Figure 10 Current De-rating**



**Figure 11 Normalized Maximum Transient Thermal Impedance**